

Product Change Notification / JAON-14VSSE190

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24-Sep-2021

Product Category:

Memory

PCN Type:

Manufacturing Change

Notification Subject:

CCB 4803 Final Notice: Qualification of MTAI as an additional final test site for selected SST39LF400A, SST39VF400A, SST39VF800A and SST39VF800A device families available in 48L TFBGA (6x8x1.2mm), 48L TSOP (12x20mm) and 48L WFBGA (4x6x0.73mm) packages.

Affected CPNs:

JAON-14VSSE190_Affected_CPN_09242021.pdf JAON-14VSSE190_Affected_CPN_09242021.csv

Notification Text:

PCN Status: Final notification

PCN Type: Manufacturing Change

Microchip Parts Affected:Please open one of the files found in the Affected CPNs section.

NOTE: For your convenience Microchip includes identical files in two formats (.pdf and .xls).

Description of Change: Qualification of MTAI as an additional final test site for selected SST39LF400A, SST39VF400A, SST39LF800A and SST39VF800A device families available in 48L TFBGA (6x8x1.2mm), 48L TSOP (12x20mm) and 48L WFBGA (4x6x0.73mm) packages.

Pre and Post Change Summary:

Pre Change Post Change

Final Test	Site	King Yuan Electronics Company, Limited (KYE)	King Yuan Electronics Company, Limited (KYE)	Microchip Technology Thailand			
Base Quantity	Tape and Reel	2500	2500	(HQ) (MTAI) 2500			
Multiple (BQM)	Tape and keel	2300	2500	2300			
Package: 48L WFBGA (4x6x0.73mm)	Tray	740	740	740			
Base Quantity Multiple (BQM)	Tape and Reel	2500	2500	2500			
Package: 48L TFBGA (6x8x1.2mm)	Tray	480	480	480			
Base Quantity Multiple (BQM)	Tape and Reel	1000	1000	1000			
Package: 48L TSOP (12x20mm)	Tray	96	96	96			
Pin Orientation	Tape and Reel	Quadrant 1	Quadrant 1	Quadrant 1			
Package: 48L WFBGA (4x6x0.73mm)	Tray	Chamfer Side	Chamfer Side	Chamfer Side			
Pin Orientation	Tape and Reel	Quadrant 1	Quadrant 1	Quadrant 1			
Package: 48L TFBGA (6x8x1.2mm)	Tray	Chamfer Side	Chamfer Side	Chamfer Side			
Pin Orientation	Tape and Reel	Quadrant 2	Quadrant 2	Quadrant 2			
Package: 48L TSOP	Tray	Oppos	ite of the chamfer side).			
(12x20mm)		See pre and post change comparison.					
Tray Co	lor	Black	Black	Black			
Package: 48L WFBGA	(4x6x0.73mm)						
Package: 48L TFBGA	(6x8x1.2mm)	See pre an	d post change compar	ison.			
Package: 48L TSOF	? (12x20mm)						
Carrier ta	ape	No dimensional change	es. See pre and post ch	ange comparison.			
Cover Ta	npe	Minor dimensional changes. See pre and post change comparison.					
Plastic R	eel	Minor dimensional changes. See pre and post change comparison.					
Packing Me	ethod	See pre and post change comparison.					

Impacts to Data Sheet: None

Change Impact:None

Reason for Change:To improve manufacturability and on-time delivery performance by qualifying MTAI as an additional final test site.

Change Implementation Status:In Progress

Estimated First Ship Date:October 11, 2021 (date code: 2142)

NOTE: Please be advised that after the estimated first ship date customers may receive pre and post change parts.

Time Table Summary:

	5	September 2021			October 2021					
Workweek	36	37	38	39	40	41	42	43	44	45
Qual Report Availability				Χ						
Final PCN Issue Date				Χ						
Estimated first ship date							Χ			

Method to Identify Change: Traceability code

Qualification Report:Please open the attachments included with this PCN labeled as PCN_#_Qual Report.

Revision History: September 24, 2021: Issued final notification.

The change described in this PCN does not alter Microchip's current regulatory compliance regarding the material content of the applicable products.

Attachments:

PCN_JAON-14VSSE190_Qual_Report.pdf PCN_JAON-14VSSE190_Pre and Post Change_Summary.pdf

Please contact your local Microchip sales office with questions or concerns regarding this notification.

Terms and Conditions:
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If you wish to <u>change your PCN profile, including opt out,</u> please go to the <u>PCN home page</u> select login and sign into your myMicrochip account. Select a profile option from the left navigation bar and make the applicable selections.

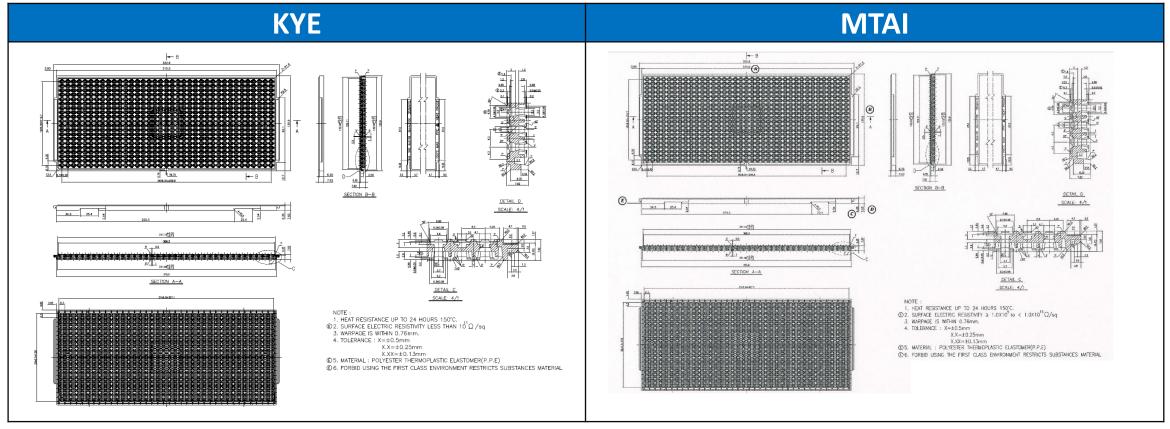
CCB 4803 Pre and Post Change Summary PCN# JAON-14VSSE190



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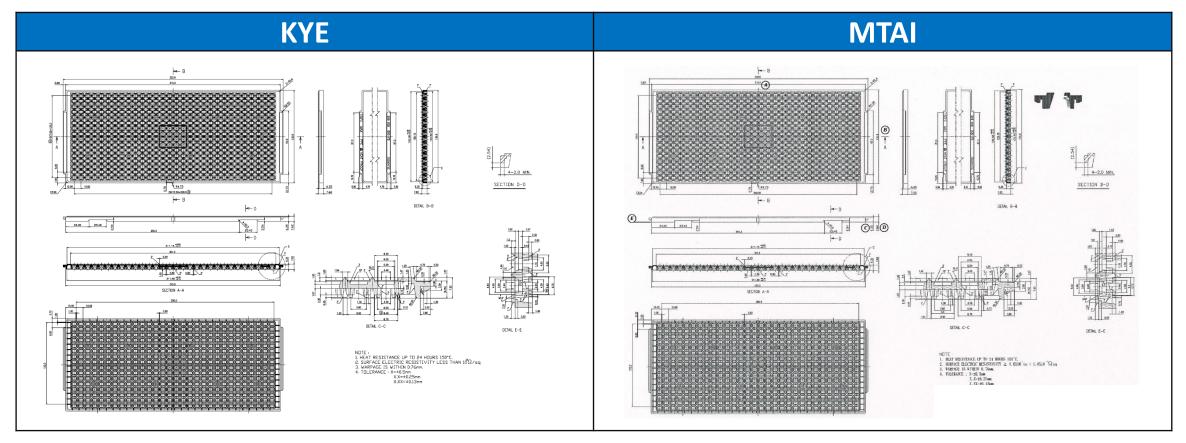
Package: 48L WFBGA (4x6x0.73mm) package



	Plant	Bakeable (Temp C)	Row	Col	Unit per Tray	Color	Tray Stack
	MTAI	150C	20	37	740	Black	10+1
I	KYE	150C	20	37	740	Black	10+1



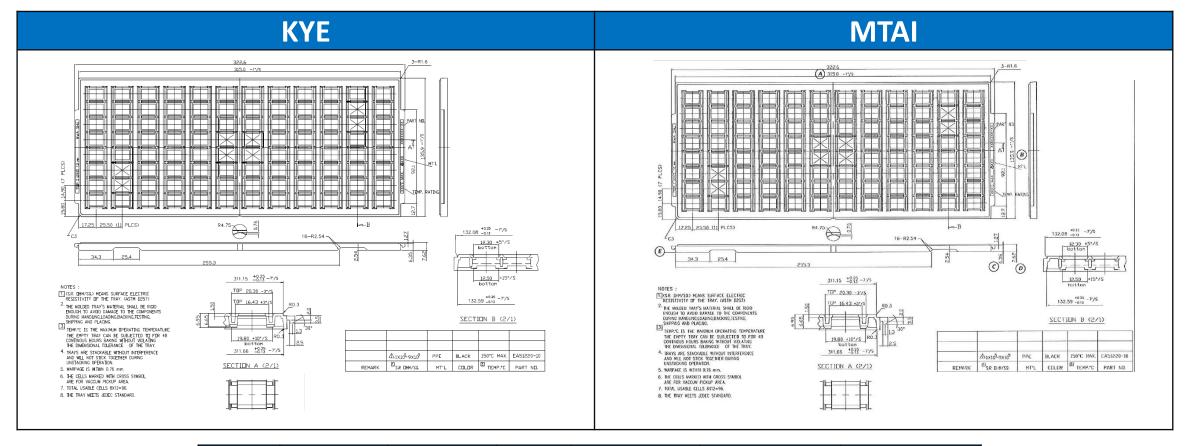
Package: 48L TFBGA (6x8x1.2mm) package



Plant	Bakeable (Temp C)	Row	Col	Unit per Tray	Color	Tray Stack
MTAI	150C	16	30	480	Black	10+1
KYE	150C	16	30	480	Black	10+1



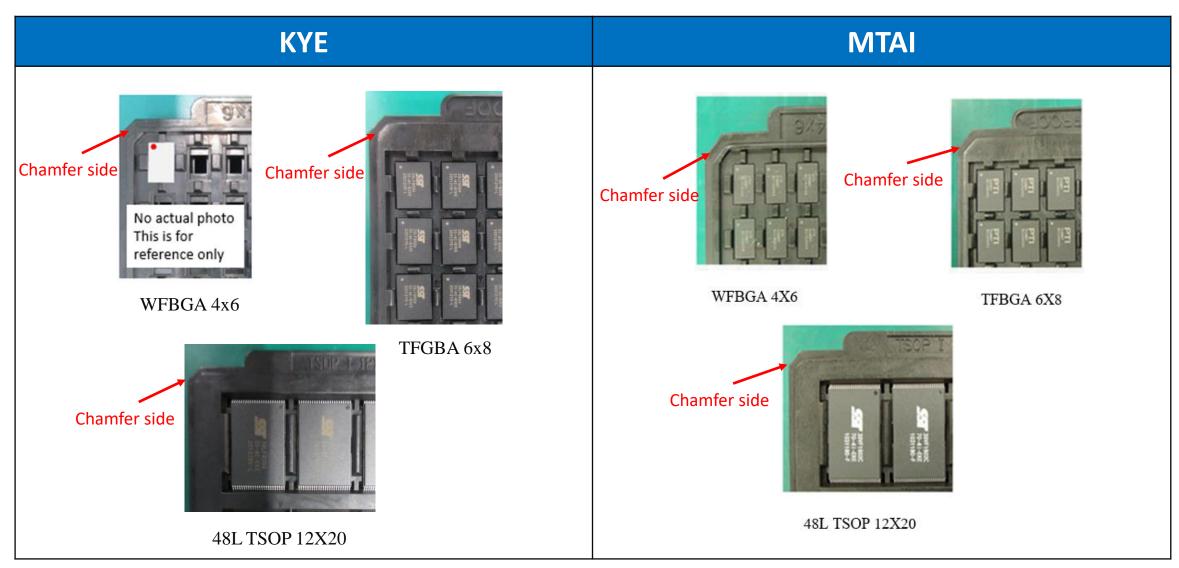
Package: 48L TSOP (12x20mm) package



Plant	Bakeable (Temp C)	Row	Col	Unit per Tray	Color	Tray Stack
MTAI	150C	8	12	96	Black	10+1
KYE	150C	8	12	96	Black	10+1

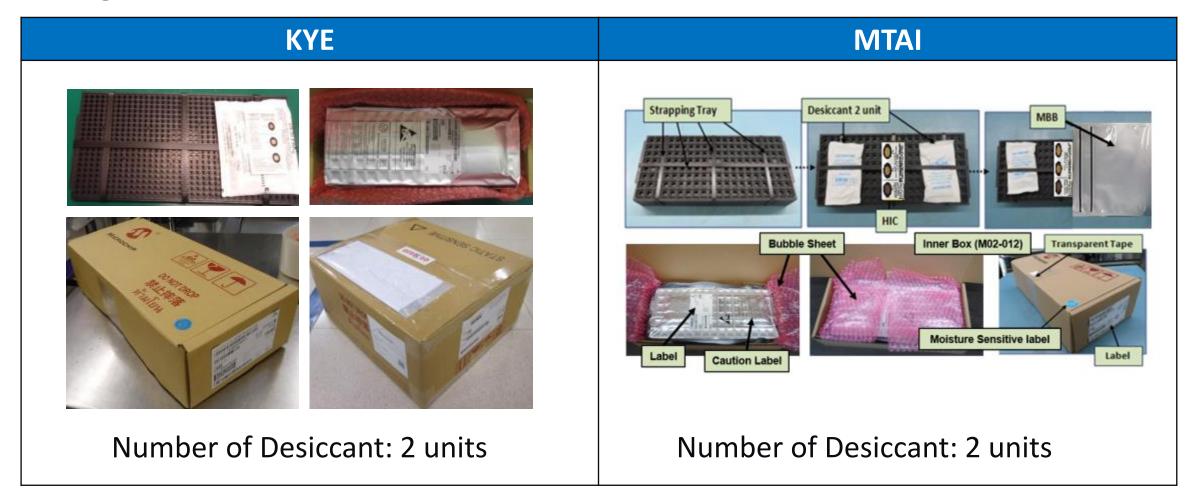


Component orientation





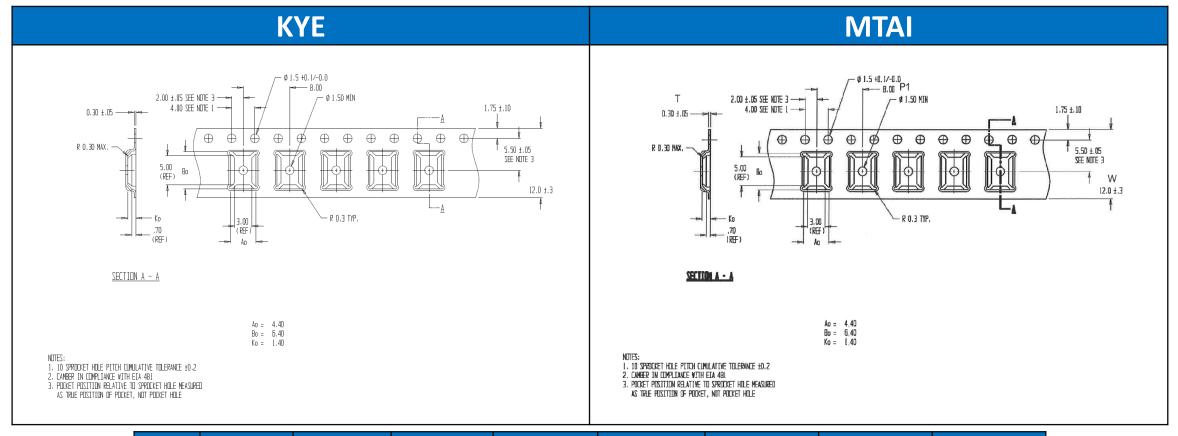
Packing Method – MSL-3





Pre and Post Change Summary – CARRIER TAPE

Package: 48L WFBGA (4x6x0.73mm) package

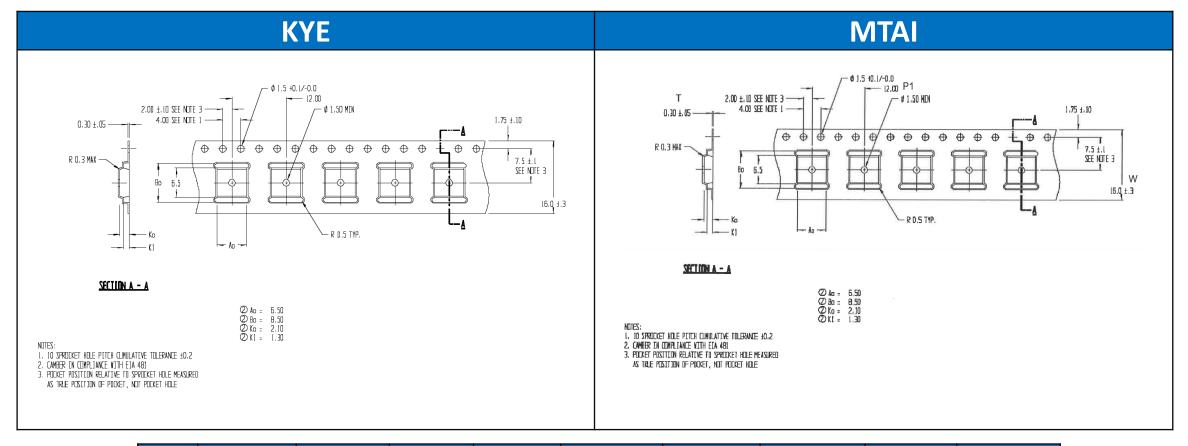


Plant	W (mm.)	P (mm.)	A0 (mm.)	B0 (mm.)	K0 (mm.)	Thickness	BQM	Pin1
MTAI	12.00±0.30	8.00±0.10	4.40±0.10	6.40±0.10	1.40±0.10	0.30±0.05	2500	Quadrant 1
KYE	12.00±0.30	8.00±0.10	4.40±0.10	6.40±0.10	1.40±0.10	0.30±0.05	2500	Quadrant 1



Pre and Post Change Summary – CARRIER TAPE

Package: 48L TFBGA (6x8x1.2mm) package

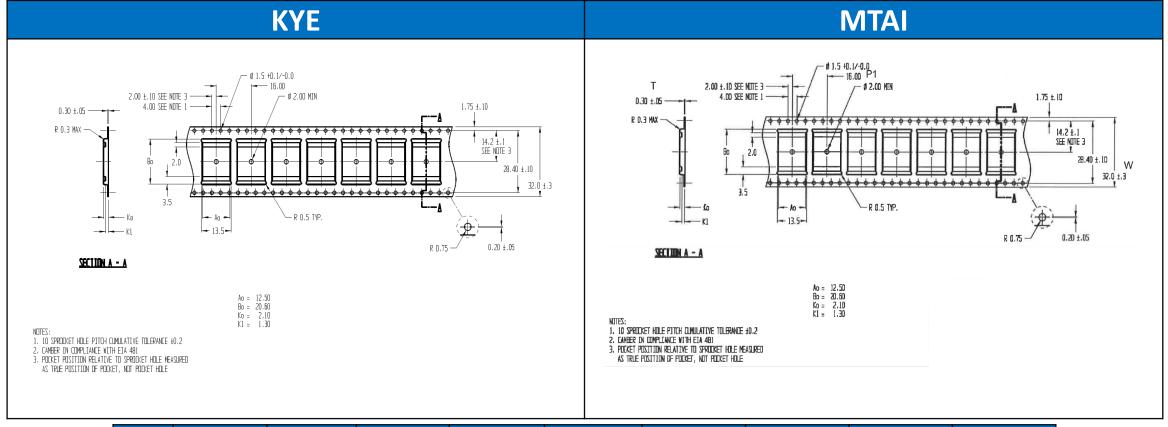


Plant	W (mm.)	P (mm.)	A0 (mm.)	B0 (mm.)	K0 (mm.)	K1 (mm.)	Thickness	BQM	Pin1
MTAI	16.00±0.30	12.00±0.10	6.50±0.10	8.50±0.10	2.10±0.10	1.30±0.10	0.30±0.05	2500	Quadrant 1
KYE	16.00±0.30	12.00±0.10	6.50±0.10	8.50±0.10	2.10±0.10	1.30±0.10	0.30±0.05	2500	Quadrant 1



Pre and Post Change Summary – CARRIER TAPE

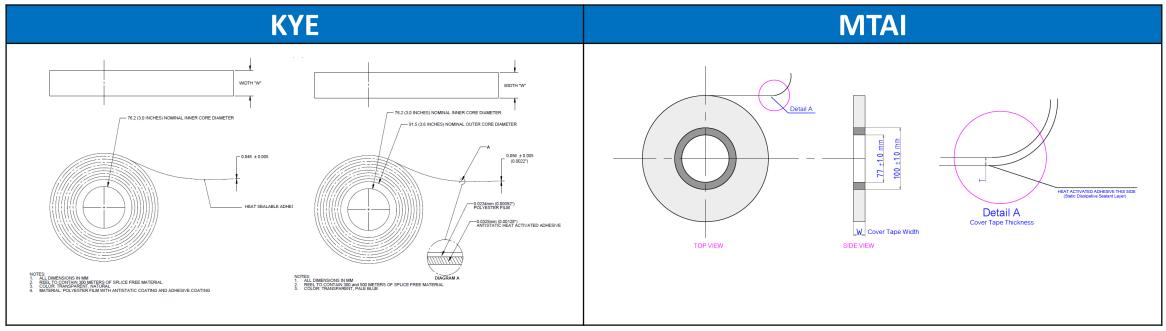
Package: 48L TSOP (12x20mm) package



Plant	W (mm.)	P (mm.)	A0 (mm.)	B0 (mm.)	K0 (mm.)	K1 (mm.)	Thickness	BQM	Pin1
MTAI	32.00±0.30	16.00±0.10	12.50±0.10	20.60±0.10	2.10±0.10	1.30±0.10	0.30±0.05	1000	Quadrant 2
KYE	32.00±0.30	16.00±0.10	12.50±0.10	20.60±0.10	2.10±0.10	1.30±0.10	0.30±0.05	1000	Quadrant 2



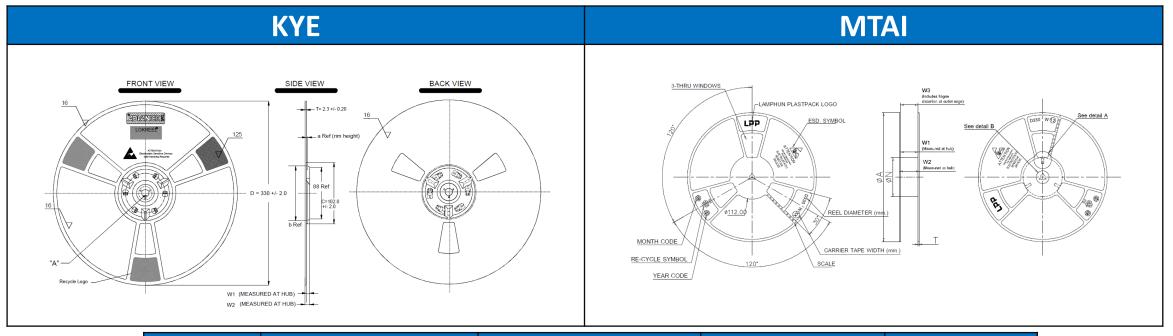
Pre and Post Change Summary – COVER TAPE



Package	Plant	Width W (mm.)	Thickness T (mm.)	Color	Sealing Methodology
48L WFBGA	MTAI	9. <mark>05</mark> +0.05 /-0.15	0.0 <mark>50 ±0.010</mark>	Clear	Heat Seal
(4x6x0.73mm)	KYE	9. <mark>3±0.1</mark>	0.0 <mark>48[±]0.005</mark>	Transparent	Heat Seal
48L TFBGA	MTAI	13.3 ± 0.1	0.0 <mark>50 ±0.010</mark>	Clear	Heat Seal
(6x8x1.2mm)	KYE	13.3±0.1	0.0 <mark>48±0.005</mark>	Transparent	Heat Seal
48L TSOP	MTAI	25.5 ± 0.1	0.05 <mark>0 ±0.010</mark>	Clear	Heat Seal
(12x20mm)	KYE	25.5±0.1	0.05 <mark>6±0.005</mark>	Transparent	Heat Seal



Pre and Post Change Summary – PLASTIC REEL



Plant	Reel Diameter (mm.)	Reel Hub Size (mm)	Reel Width Max (mm.)	Color
MTAI	330 ±2.0	10 <mark>0</mark> ±2.0	18. <mark>4</mark>	Dark Blue
	330 ±2.0	10 <mark>0</mark> ±20	22. <mark>4</mark>	Dark Blue
	330 ±2.0	10 <mark>0</mark> ±2.0	38. <mark>4</mark>	Dark Blue
KYE	330 ±2.0	10 <mark>2</mark> ±2.0	7.1 + = 18. <mark>2</mark> 11.1	Regrind Blue
	330 ± 2.0	10 <mark>2</mark> ± 2.0	11.1 + = 22. <mark>2</mark> 11.1	Regrind Blue
	330 ±2.0	10 <mark>2</mark> ±2.0	19.1 + = 38.2 19.1	Regrind Blue



Pre and Post Change Summary – TAPE and REEL

Packing Method – MSL-3



Plant	MSL Level	Desiccant	Humidity Indicator Card	Baking Condition
MTHAI	MSL-3	2 units	1 pcs	2 hours @125C
KYE	MSL-3	2 units	1 pcs	2 Hours @125C





QUALIFICATION REPORT SUMMARY

PCN #: JAON-14VSSE190

Date September 15, 2021

Qualification of MTAI as an additional final test site for selected SST39LF400A, SST39VF400A, SST39LF800A and SST39VF800A device families available in 48L TFBGA (6x8x1.2mm), 48L TSOP (12x20mm) and 48L WFBGA (4x6x0.73mm) packages.

Purpose: Qualification of MTAI as an additional final test site for selected SST39LF400A,

SST39VF400A, SST39LF800A and SST39VF800A device families available in

48L TFBGA (6x8x1.2mm), 48L TSOP (12x20mm) and 48L WFBGA

(4x6x0.73mm) packages.

CCB No.: 4803

Test / Evaluation	Test / Evaluation Test Conditions / Parameters	
Original Final Test Site Correlation	, ,	
Destination Final Test Site Correlation	Send 5,000 tested devices from 1 lot for Commercial/Industrial. The results need 100% correlation. To ensure that correction result. Re-test the ALL devices from the original test site bin-by-bin to the destination site test program for correlation. The yield difference should be within 0.1% and bin-to-bin difference should be within 0.1%	PASS

JAON-14VSSE190 - CCB 4803 Final Notice: Qualification of MTAI as an additional final test site for selected SST39LF400A, SST39VF400A, SST39VF800A and SST39VF800A device families available in 48L TFBGA (6x8x1.2mm), 48L TSOP (12x20mm) and 48L WFBGA (4x6x0.73mm) packages.

Affected Catalog Part Numbers (CPN)

SST39LF400A-55-4C-MAQE

SST39LF400A-55-4C-B3KE

SST39LF400A-55-4C-EKE

SST39VF400A-70-4I-M1QE

SST39LF400A-55-4C-MAQE-T

SST39LF400A-55-4C-B3KE-T

SST39LF400A-55-4C-EKE-T

SST39VF400A-70-4I-M1QE-T

SST39LF800A-55-4C-MAQE

SST39VF800A-70-4C-M1QE

SST39LF800A-55-4C-B3KE

SST39LF800A-55-4C-EKE

SST39VF800A-70-4I-M1QE

SST39LF800A-55-4C-MAQE-T

SST39VF800A-70-4C-M1QE-T

SST39LF800A-55-4C-B3KE-T

SST39VF800A-70-4I-M1QE-T